2021-22/02/32 Dielectric strength tester

S. no.	Item	Specification
		To determine the dielectric
		breakdown voltage through the
1		thickness of a Polymeric test
Ŧ	TYPES OF TESTS TO BE	specimen. It may also be used to
	PERFORMED	determine dielectric breakdown
		voltage along theinterface
2		between a solid specimen in air and
		oil medium.
		Should be complied to ASTM D 149,
3	APPLICABLE STANDARD	ISO 1235, BS 2782 Method 201, IS
		0-100 kV(Suitable for BDV up to 100
		KV without external flashover). Mode
4	Capacity	of operation Fully automatic.
		Breakdown detection should perform
		in terms of both Voltage and Current.
		Suitable step-up Transformer
		supplied from a variable sinusoidal
5		low-voltage source with Voltage
		capacities range 0 to 100 kV rms
6	Valtara Sauraa	With ratio of crest to root-mean-
6	Voltage Source	square (rms) test voltage, equal to
7		$\sqrt{2 \pm 5\%}$ (1.34 to 1.48), with the test
		specimen in the circuit, at all voltages
,		greater than 50 % of the breakdown
		voltage.
		Colour display with backlight. The test
		set should give all the test results with
	Display	standard deviation, average of
		reading and a pass / fail message
8		wherever necessary on LCD/LED
		screen, Instrument should have
		alphanumeric keypad to facilitate
		entry of test ID notes etc
9	Frequency	from 25 to 800 Hz
-		Suitable as per Method A.B. & C of
10	Voltage rise time& accuracy	ASTM D 149 & other standard as
		mentioned.
11	Voltage rise time Resolution	0.1 kV ±1%
	-	Air & Oil medium. Suitable Oil media
12	Test Vessels/Medium	Tank in line with the requirement of
		Standard

13	Test Temperature range	Ambient to 100°C. Suitable heaters should be provided for heating oil bath. Test kit should have automatic oil temperature measurement facility with a temperature sensor resolution of 1°C or better.	
14	Temperature resolution	1 °C or better	
15	Power supply	voltage - 85 to 265 VAC	
16		frequency - 50/60 Hz	
17	Interface	RS-232 interface, I/O port with safety interlock, USB Host Port for Data/Program storage	
18	Protection provided to equipment	Dual safety micro switches on chamber cover. HV Chamber interlocking. Zero starts interlocking Test Kit Trip time should be less than 10 microsec. The HV switch OFF time (automatically) if an established arc of 4 mA occurs for 5 msec should be less than 10 µs.	
19		AC/DC Digital Voltage Meter: 50,100,150,200kV	
20	Mandatory Items With the Machine	DC micro-ammeter	
21		Electrode set of Type 1 to Type 7 as per standard	
22		 Vendors must have sufficient experience in supplying equipment to reputed organizations of Plastic/polymerIndustries 	
23	Additional Requirements - Special	Magnetic bead stirrers	
24	Features Needed	Sample cutter as per standard.	
25		 A suitable Voltage calibrator meter should be provided along with equipment which should be oil free 	
26		While supplying the Machines, the supplier should also provide the following items apart from above:	
27		Hard copies of Operational & Service Manual-01Set.	
28	Other Mandatory Items	 Traceable Calibration certificate ofequipment. 	
29		• External printer with USB interface and PCL3driver	
30		 Machine should come with all other essential accessories & spares required for installation, commissioning&Operation 	

S. no.	Item	Specification	
1	Purpose	✓ Storage of air sensitive chemicals and fabricated devices.	
2		 ✓ Fabrication of high end electronics, energy storage and energy conversion devices 	
3	Glove box	Glove box with 4 port	
4	Moisture level Requirements	< 1.0ppm	
5	Oxygen Level Requirement	<1.0 ppm	
6	Environment	Nitrogen and Argon	
7	Material of construction	Stainless Steel of high quality (grade to be mentioned by bidder)	
8	Box Windows	Transparent safety glass which can retain pressure range of -15mbar to +15mbar	
9	Pressure	Automatic Pressure control from-15 mbar to+15mbar with oil free over pressure relief valve	
10		 ✓ Continuous Digital Pressure monitoring of the glove box 	
11	Display of Reading	High accuracy sensor based reading of moisture and oxygen level in ppm levels to be displayed at all-time along with Glove box pressure, purging condition, regeneration etc. which should be monitored/controlled through a plc based control system. Provision for 24/7 remote monitoring facility is required.	
12		 Scratch proof coating to protect the inner and outer housing 	
13		Dust filter of 0.3 micron	
14		Gas inlet and outlet filter.	
15		3 height adjustable shelves	
16	Box	3 Electrical feed through	
17		 Stand for the box along with levelling 	
18		 Foot pedal control of the internal pressure 	
19		Waterproof	
20		 One antechambers made up of stainless steel with metal doors which can be interlocked to maintain pressure range of -10 mbar to 10 mbar. 	
21		 Pressure gauges to monitor the pressure. 	

22	Antechamber Large	 Metal Sliding tray to transport sample
23		 Manual Control of Vacuum and Refill process
24		 Door lock easy to operate with a spindle lock system
25		• One large antechamber for transporting larger volume inside the glove box. At least 390 mm diameter, 600 mm length
26	Antechamber Small	 Small Antechamber to allow transfer of Min. 100 mm Petridis diameter.
27		• 3 way valve control with analog pressure gauge.
28	Gas purification	• Closed loop gas purification with attainable moisture and oxygen level of < 0.1 ppm over complete pressure range for the complete volume of gas.
29		 Accessories and columns required for the gas purification should be provided by bidder.
30	Circulation Unit	Suitable blower with 80m3/hour or better capacity should be provided with the unit for adequate circulation along with other accessories. Should be fitted with heat exchanger and suitable recirculation unit.
31	Regeneration	Automatic regeneration control and electronic control of inlet and outlet of regeneration gas.
32	Vacuum Pump	Rotary Oil Pump of industrial required which will be capable of running 24hours. The pump should have an oil mist filter and control for gas ballast. 17m3/hour capacity or better
33	Control System	Rotary vane mechanical vacuum pump with necessary moisture and vapour traps details should be provided
34	Running Time	The instrument and the ancillary vacuum pumps should be capable for running 24 hours
35	Box Dimensions and number of	✓ □ Suitable dimension to allow minimum 4 port in front to be used for accessing the box.
36	ports	 ✓ Typical dimension of each glove port would be 200mm-220 mm diameter

37		The glove box and its parts should be compatible for storage and usage of
38	Chemical Storage Requirements	• Organic solvents both chlorinated and unchlorinated.
39		Use of electrolytes and ionic liquids
40		 Intermittent usage of acids and bases
41	Box Light	1 or 2 tube light front mounted with adequate illumination.
42	Valves and Piping	• Pneumatic Valve to control pressure in case of gas shut down for at least 12 hours.
43		Stainless Steel Piping
44		PLC controlled analyzer tomonitor from1–1000ppm
45		• Operating Temperature: ambient to 35°C
46		 Pressure - 800 - 1200 hPa
47		 Sensitivity - 10 mV/ppm(v)
48		Response time- < 10 sec
49	Oxygen Analyzer	 Accuracy: +/- (2 % of displayed value + 1 ppm)
50		 Zero Stability: <1ppm/24 h
51		• Repeatability: +/- 1% in full range
52		• Resolution: +/- 0.1% in full range
53		Solid state type
54		 Should be free from frequent Calibration
55	Moisture Analyzer	PLC controlled analyzer tomonitor from1–500ppm
56		Solid state type
57	Filters	Charcoal Filter or better system for moisture removal to achieve the required level of moisture asspecified.
58	Catalyst for Oxygen	Suitable technology for oxygen removal to achieve the required level as specified
59	Energy Conservation	Any energy conservation technology would be preferred
60		Piping and fittings Should be made of stainless steel
61	Others	• Electrical · Lighting: Internal LED/fluorescent lamp and provision of electrical points inside the chamber with leak proof sealing
62		Operating voltage: 230 V (±10 %), 50 Hz

63		• Additional 03 pair of gloves and O
05		rings
64		Rotary oil
65	Accessories	Nitrogen and argon cylinder with
05		regulator
66		 Required additional accessories
00		should be provided.

S. no.	ltem	Specification
1	Purpose	An Electrical Characterization System to perform device characterization, real-time plotting, and analysis withhigh precision and resolution, while remaining a highly integrated, flexible, upgradable and user- friendlypackage.
2		The system should be capable to perform the I-V and C-V characterization of Thin Films, Electronic materials, Semiconductor devices, Solar Cells, High resistive materials and nano materials etc.
3		 Single box solution for current- voltage (IV), CV, pulse generation upgradable (Fast IV) capability with built in PC.
4		 Slot system for Source measure unit (SMU), Capacitance-voltage unit (CVU) and pulse IV modules.
5	Features	 Should be compatible with automatic/semiautomatic prober.
6		 All SMU should provide voltage/current in Bias; Common; Sweep; List sweep (custom point-by- point user-defined sweep); Step mode.
7		 SMU should able to apply pulse in mS range.
8	No of SMU	3 expandable upto 9
9	Type of SMU	High Power -1; Medium-2
10	Display	Built in 12.5 TFT display or better
11	Voltage Source and measure	
12	range	200 mV to 200V or better
13	Voltage Resolution	Source: 5 μ V and measure: ± 200nV or better
14	Current Source and measure ranges	1 pA to 100mA or better

2021-22/02/48 Semiconductor measurement with Probe Station

		Source: 1.5pA Measure: + 100 aA		
15	Current Resolutions	or better		
16		Frequency Range:1KHz to 10 MHz		
17		variable.		
18	Built in C-V Measurement	DC Voltage Bias: + / - 30V / 1mV		
19	capability	resolution.		
20		Measurement Parameters:CS-GS,		
20		CP-GP, Z theta, Cs-D, Cp-D, R+jX		
21				
21		Frequency range: 10 mHz to 10 Hz.		
22	System should have Very Low	Voltage: up to 200 V.		
	Frequency CV capability.			
23		VLF measurement models: CS-GS,		
		CP-GP, Z theta, Cs-D, Cp-D, R+jX.		
		In-Built PC platform with windows-		
		OS,having LAN; GPIB; USB; RS232;		
24	Hardware/ Architecture	parallelport; HDD,CD-RW;Should		
		provide libraries / projects		
		formeasurement of device		
		parameters forsemiconductors.		
25		230V AC, +/- 10%; 50Hz.		
26	Accessories	Low Noise Triax Cable-03		
27		Piv Demo Fixture		
20	1. System should have built in C	apability to switch the measurements		
28	Itrom IV, CV to optional upgradable Pulsed IV from select menu without			
20	Changing the connections on the Du	JI.		
29	2. System should have reivin connection at GND unit.			
30	for hardware configuration. System should have facility to modify or write			
50	user test modules			
31	4. Provided software should have parameter extraction facility			
	5. System to be supplied along with two numbers of triaxial to alligato			
32	cables.	C C		
22	6. The Instrument should have ca	apabilities of self-test, calibration and		
	diagnostic.			
34	All standard accessories should be	supplied with the Instrument.		
35	The Instrument should be provided	with built in software having following		
	teatures:	and the second		
36	Following kind of I-V measureme	ent using current source or voltage		
27	SOUICE.	historica		
3/	1. (I) Voltage vs current for high resistance,			
38	2. (II) CUITETIL VS VOILAGE FOR IOW FES			
39	3. (III) I WO TERMINAL I-V TOR GIODE			
40	4. (IV) I nree terminal I-V for MOSEET.			
41	b) Live graph plotting			
42	b) Live graph plotting.	a filma		
43	C) Parallel testing of two resistor/thin films.			
44	a) resting of three terminal devices.			
45	analysis	ave parameter extraction raciity and		
16	Probe Station (/ Inch wafer)			
-+0		○ The Probe System must be able to		
47		support the following on-wafer		
L	J			

48		 measurement setup
		○ DC and CV (DC to 5MHz)
49		parametric
50		o measurements
	Specifications of Manual 4 Inch	 DC Probe card measurement
51	wafer probe station - Parameters	setup. The chuck should be RF
		compatible.
52		 IV / CV measurements applications
		 RF probing
53		(East/West/North/South
		Configuration)
F 4		
54		Chuck Stage Movement - Manual
55		 Chuck X-Y Stage - Independent X
		and Y Axis control of the chuck stage
56	Probe System Integration.	 X-Y stage travel range ≥ 100 mm
50		(X axis) ≥ 100 mm (Y axis)
		 Chuck Z Stage measurement sub-
57		systems Optimized Z Stage
57		movement to keep the DUT in focus
		during probing.
58		4" Gold plated Aluminium Vacuum
50		Chuck
59		 Vacuum Rings x2 for wafer 4" and
		single die
60		Coaxial Chuck Stage X-Y 4"-4"
61	C-4 Mini Station	Resolution 10 micron
62		• U Platen Bar (Ferro, Hard chrome
		plated)
63		
		Chuck UP/DOWN -5 mm-2 motion
64		Chuck Theta 15 degrees
65		• E.P. 10X-30X
66		• Zoom 1X~ 5X
67		Iotal Mag. 10X~150X
68	Stores Misrosses	LED light source
69		CIVIUS Digital Camera:
70		
		KIT: DIgital CCD
71		• SIVIE, CCD Adapter, Calibration
		Micro positionar EP 050DC/PE
72		l ingar X-V-7 Travel 12mm-12mm
		• 12mm 80 Thread/Inch /Pog 0.9
73		micron per degree)
7/		Magnetic ON/OFF Base
/4		Platen maximum number of
75		nositionere -> 10 no's

76	Platen	 Loading and Unloading of Wafer - The systems should support front loading and unloading wafer with clear view of the wafer or substrate
77		 vacuum control, integrated service loop for stable X Stage Movement. All Safety Hazards must be clearly indicated
78		Minimum Wafer Size - 10 mm dia
79		 Maximum Wafer Size Support - ≥ 100mm dia
80	Wafer Chuck System	 Chuck Diameter - ≥ 100mm dia
81		 Chuck Surface condition - Gold Plated Aluminium with vacuum holes actuation Chuck Surface Flatness or Planarity - ≤ 10 μm
82		Triaxial type Tip Holder - Spring type:
83		Triaxial cable 1.5-meter-long terminated with triax male.
84	Wafar Obush	 For CV measurement: shield terminated with crocodile clip to ground with Chuck.
85	vvater Chuck	 Dry Vacuum pump-7 Lit/min: suitable to system with all tubing and vacuum switches.
86		 Probe tips: 5-micron dia (Box of 10)-2
87		 10-Micron dia -Gold plated tungsten tips
88	Hot Chuck:	 Vacuum Chuck for wafer 4" and less with individual vacuum switches,
89		 Room Temp ~ 200 °C,
90		 DC –Powered, PID Controller

2021-22/02/49 Shore hardness tester A & D

S. no.	Item	Specification	
1	Purpose	It is an instrument which is used to measure the hardness of a material. Hardness may be defined as a material's resistance to permanent indentation.	
2	Principle/ Definition	Resistance of solid matter to various kinds of permanent shape change when a compressive force is applied.	
3	Reference Standard	Should be complied to ASTM D2240, I	SO 7619, ISO 868

4		Shore A	Shore D
5	Test Scale	(hardness testing of soft rubber, plastic and such substances)	(hardness testing of hard rubber, plastic and such substances)
6	Display	Bright & clear LCD display	Bright & clear LCD display
7	Result display	Hardness result, average value, max value (peak value lock), battery indication	Hardness result, average value, max value (peak value lock), battery indication
8	Data output	RS232	RS232
9	Measuring range	0~100HA	0~100HD
10	Tolerance	≤ ± 1HA (between 20~90HA)	≤ ± 1HD (between 20~90HD)
11	Display resolution	0.2 HA	0.2 HD
12	Statistics	Highest hardness, average	Highest hardness, average
13	Operating temperature	$0 - 40$ $^{\circ}C$	$0 - 40^{-0}$ C
14	Features	Automatic switch off, battery low alarming	Automatic switch off, battery low alarming
15	Power Supply	3 x 1.5V-Buttonbatteries or 4.5V AC/DC adapter	3 x 1.5VButton batteries or 4.5V AC/DC adapter
16	Other features	Pocket size model with integrated prob	De
17		While supplying the Machines, the sup provide the following items apart from	pplier should also above:
18		 Hard copies of Operational & Ser Set 	vice Manual- 01
19	Other Mandatory Items	 Machine should come with all other accessories, computer & spares require commissioning& Operation 	er essential red for installation,
20		 Onsite Training to be provided for commissioning site. 	CIPET staff at

2021-22/02/52 Thermal Evaporator System

S. no.	ltem	Specification
1	Application	Thermal Evaporation system should be capable of depositing metals / metal oxides / ceramics with uniform film thickness

2	Vacuum Chamber	• SS 304 Metal Chamber fabricated from polished stainless steel.
3		 Approximately 16" x 16" x 18" Height with front door opening.
4		• Cooling water pipeline is coiled on the outer wall of the chamber to prevent overheating, especially at the chamber windows and to reduce the out gassing by circulating the water and viewing window. There should be provision for necessary feed through.
5	High Vacuum Pumping System:	 The chamber is evacuated by a double stage direct drive, rotary vacuum pump, with Edward Turbo pump for high vacuum.
6		 Rotary pump (with appropriate oil/mist filter) for creating initial vacuum till 10⁻³ mbar and backing for the turbo pump after that.
7	Rotary Vacuum Pumping System	(1 No) Capacity 250 LPM, Direct drive, Single phase, Double stage, Oil charge 0.75liters, Ultimate vacuum > [5-6] x10 ⁻³ m. bar.
8		The pump should be capable for running 24 hrs.
9		nEXT400D ISO100 160W with inlet screen and manual vent valve Having Field replaceable bearing.01No.
10	Turbo Pumping System	01.Effective Pumping speed - >300(LPS)
11		02. Ultimate vacuum - 10 ⁻
12		03. Critical backing pressure -
13	Motorized High Vacuum poppet type valve	Motorized high vacuum Poppet type valve with built in facility to automatically throttle the pumping system by 'cracking' the valve, for maintaining accurate process pressure for plasma processes. This valve isolates the chamber from the pumping system so that the chamber can be brought to atmospheric pressure without switching off the pumping system. The Drawing of Poppet valve should be provided along with the Technical bid.

14	Electro magnetically operated right angle valves	Electro magnetically operated right angle bellow sealed valves for roughing , backing and high vacuum applications
15	(1 No) Electro magnetically operated Vent valve	suitable size Electro magnetically operated Vent valve is fixed to the chamber pipeline to release the chamber vacuum after each coating process cycle
16	Needle Valve	[2 Nos] along with the unit for gas purging. A fine control needle valves providing in the pipeline for use during H.T. discharge cleaning.
17	L.T/H.T Control	Thyristor Controller in the input circuit of LT/HT selector provides the output power variation.
18	Meters	Separate digital panel meters provided for HT primary current LT secondary current through current transformers
19	Indicator Lamps	Glow lamps are to indicate ON/OFF status of rotary pump, Turbo pump, LT, HT and other accessories.
20	Power connection	For connection the power to the system 2 meters long 15amps wire chord with plug.
21	Vacuum Measuring Gauges	Digital Pirani Gauge -(1 No): Measure vacuum from 0.001 to 1000 m.bar anywhere in the vacuum system with suitable adaptor. Two gauge heads should be to this gauge to read fore vacuum and roughing vacuum of the system.
22		Digital Penning Gauge- (1No): Measure vacuum from 9.9x10 ⁻³ to 1.0x10 ⁻⁶ m.bar anywhere in vacuum system with suitable adaptor.
23	LT Evaporation Feedthroughs	Atleast 3 No. of LT electrical feed- through for evaporation, made of electrolytic pure copper with 200Amps current carrying capacity should be provided.

Substrate Holder, Heater & Rotation	Capable of holding various dimensions of substrate 100 mm or higher diameter disc or multiple smaller size substrates. Designed for long, trouble free operation. Rotation speed adjustable 20rpm or higher. A suitable Substrate Heater should be provided for varying substrate temperature from RT to a maximum of 500 Deg.C with a thermocouple and PID temperature controller. The substrate heater should be oxygen compatible up to maximum temperature. Temperature accuracy should be within ±5 Deg.C Substrate rotational capability at elevated temperature. Simultaneous rotation & heating mechanism.
Substrate cooling facility	To be provided through water piping (as main quotation).
	Liquid nitrogen cooling facility can be provided as additional cost.
Digital Thickness monitor	 Appropriate feed through and sensor to be provided close to the LT source.
	Ability to monitor evaporation rates of 0.1 Å/s
	• 6 MHz crystal holder with oscillation box and connecting cables.
	Display:3digit LED.
Quartz Crystal Thickness Monitor (DTM):	• Thickness Display 4Digit LED auto ranging from 0.000 to 999.9 Å,
	Crystal Frequency: 6MHz
	 Thickness Set point 0.000 to 999.9KÅ,
	Film Dencity:0.800 to 99.99grams/cc.
	Control console is fabricated with mild steel and neatly powder coated. It is provided to house all the electrical control instrumentation, control switches and standalone control panel of the following switches;
Control Console	 ✓ ON/OFF switches for vacuum pumps and all valves
	Substrate Holder, Heater & Rotation Substrate cooling facility Digital Thickness monitor Quartz Crystal Thickness Monitor (DTM): Control Console

27]	✓ vacuum measuring gauges
37		controller
20		✓ Substrate rotation and substrate
50		heater controls
		The above control console is wired to
39		operate on 230 V AC, 50Hz, Single
		phase power supply.
40		Should be made out of MS
40	Support atructure	channel and angles, neatly painted
41		Must have castor wheels for
41		mobility purpose.
42	Source shutter	To cover the evaporation source
42		Unit operates on 220V A.C 50Hz
43	Electrical Controls	single phase power supply.
		A 200Amps power supply capable of
44	L.I Power Supply	delivering (3 nos)
45		5000volts DC open circuit.
4.0	H.T Power Supply	3500volts at 50mA high reactance
46		type-1NO
	Safety Devices	An electrical circuit breaker in
		different power supply line protects
47		these against over-load shorting. An
47		over load protection device for
		vacuum pump motor should be
		provided.
	Ultimate Vacuum	The unit is specified to achieve an
		ultimate vacuum of 1 ×10 ⁻⁶ m.bar in
48		clean cool empty degassed condition
		within 1 hour of switching on of the
		pumping system.
	Purging	Nitrogen and Air purging facility
49		should be available
	Manual	Operation Manual to be given after
50		delivery and installation
51	Inspection	CIPET will inspect the instrument for
		two complete runs before despatch
		from factory outlet.
52	Water Chiller	Suitable capacity Water chiller to
		be provided for the whole unit with
		interlocks, tank,etc.